300 mA, Low Dropout Regulator

The NCP4683 is a CMOS Linear voltage regulator with 300 mA output current capability. The device has high output voltage accuracy, low supply current and high ripple rejection. The NCP4683 is easy to use, with output current fold–back protection circuit included. A Chip Enable function is included to save power by lowering supply current. The line and load transient responses are very good, thus this regulator is suitable for use as a power supply for communication equipment.

Features

- Operating Input Voltage Range: 1.40 V to 5.25 V
- Output Voltage Range: 0.8 V to 3.6 V (available in 0.1 V steps)
- Output Voltage Accuracy: $\pm 1.0\%$ (V_{OUT} > 2.0 V)
- Supply Current: 50 µA
- Dropout Voltage: 0.25 V ($I_{OUT} = 300 \text{ mA}, V_{OUT} = 2.8 \text{ V}$)
- High PSRR: 70 dB (f = 1 kHz)
- Line Regulation: 0.02%/V Typ.
- Stable with Ceramic Capacitors: 1.0 µF or more
- Current Fold Back Protection
- Available in UDFN4 1.0 x 1.0 mm, SC-70, SOT23 Packages
- These are Pb–Free Devices

Typical Applications

- Battery-powered Equipment
- Networking and Communication Equipment
- Cameras, DVRs, STB and Camcorders
- Home Appliances

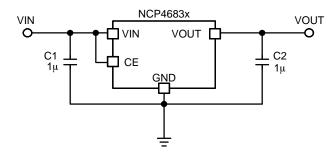
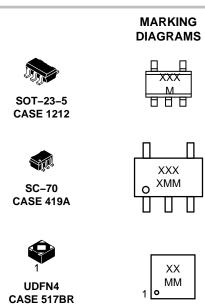


Figure 1. Typical Application Schematic



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XX, XXX, XXXX = Specific Device Code M, MM = Date Code

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 18 of this data sheet.

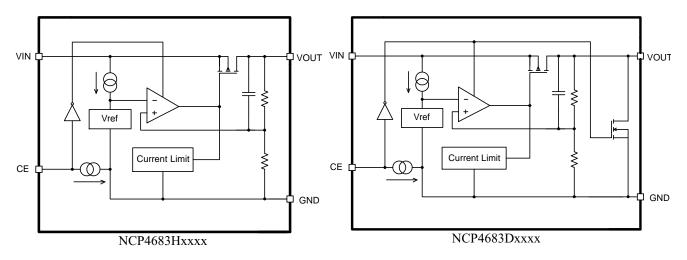


Figure 2. Simplified Schematic Block Diagram

PIN FUNCTION DESCRIPTION

Pin No. UDFN1010*	Pin No. SC-70	Pin No. SOT23	Pin Name	Description
1	4	5	V _{OUT}	Output pin
2	3	2	GND	Ground
3	1	3	CE	Chip enable pin (Active "H")
4	5	1	V _{IN}	Input pin
-	2	4	NC	No connection

*Tab is GND level. (They are connected to the reverse side of this IC.

The tab is better to be connected to the GND, but leaving it open is also acceptable.

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage (Note 1)	V _{IN}	6.0	V
Output Voltage	V _{OUT}	-0.3 to VIN + 0.3	V
Chip Enable Input	V _{CE}	-0.3 to 6.0	V
Output Current	I _{OUT}	400	mA
Power Dissipation UDFN1010	P _D	400	mW
Power Dissipation SC–70		380	
Power Dissipation SOT23		420	
Junction Temperature	Τ _J	-40 to 150	°C
Storage Temperature	T _{STG}	-55 to 125	°C
ESD Capability, Human Body Model (Note 2)	ESD _{HBM}	2000	V
ESD Capability, Machine Model (Note 2)	ESD _{MM}	200	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

2. This device series incorporates ESD protection and is tested by the following methods:

ESD Human Body Model tested per AEC–Q100–002 (EIA/JESD22–A114) ESD Machine Model tested per AEC–Q100–003 (EIA/JESD22–A115)

Latchup Current Maximum Rating tested per JEDEC standard: JESD78.

THERMAL CHARACTERISTICS

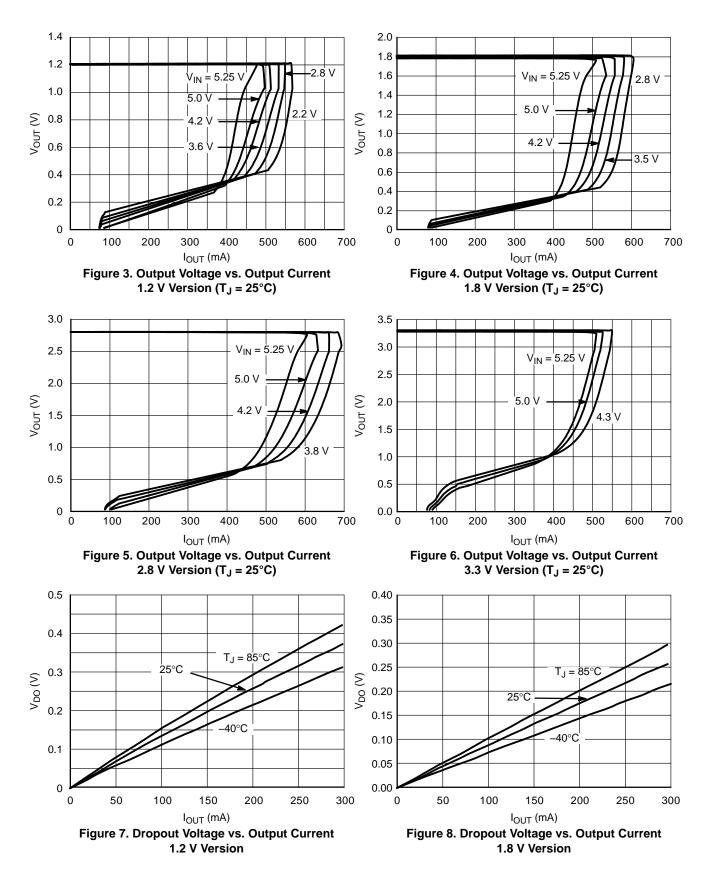
Rating	Symbol	Value	Unit
Thermal Characteristics, UDFN 1.0 x 1.0 mm Thermal Resistance, Junction-to-Air	$R_{ heta JA}$	250	°C/W
Thermal Characteristics, SOT23 Thermal Resistance, Junction-to-Air		238	°C/W
Thermal Characteristics, SC–70 Thermal Resistance, Junction–to–Air	$R_{ hetaJA}$	263	°C/W

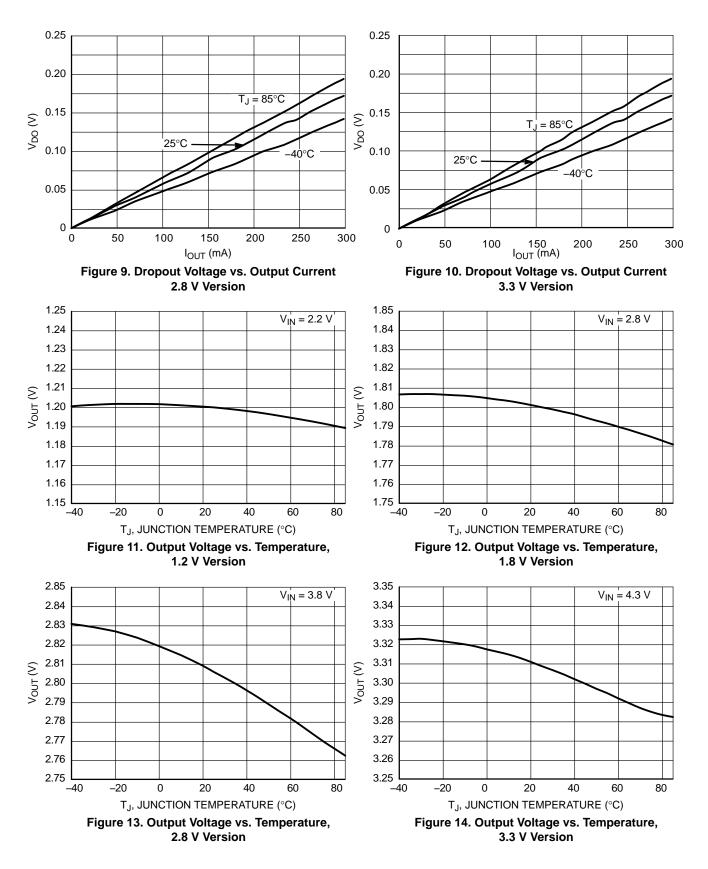
ELECTRICAL CHARACTERISTICS

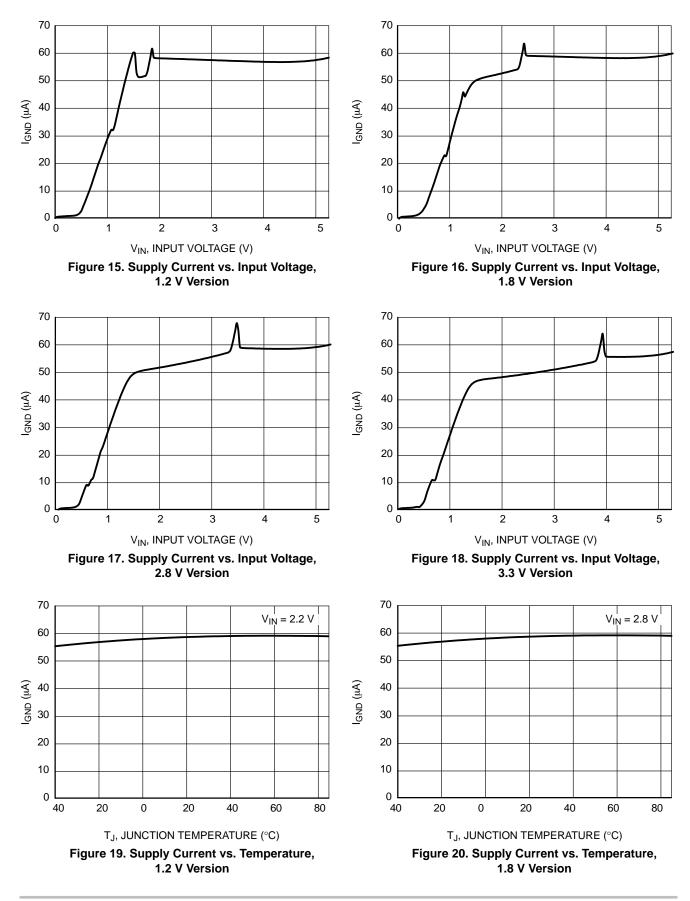
 $-40^{\circ}C \le T_A \le 85^{\circ}C$; $V_{IN} = V_{OUT(NOM)} + 1$ V or 2.5 V, whichever is greater; $I_{OUT} = 1$ mA, $C_{IN} = C_{OUT} = 1.0 \ \mu$ F, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.

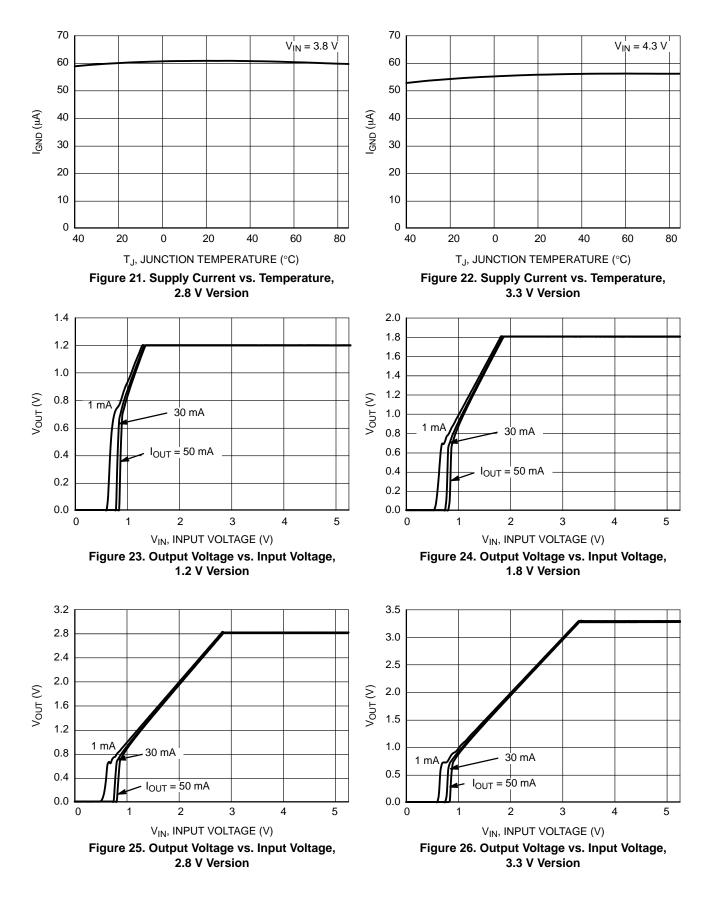
Parameter	Test Conditions		Symbol	Min	Тур	Max	Unit
Operating Input Voltage			V _{IN}	1.40		5.25	V
Output Voltage	T _A = +25°C	$V_{OUT} \ge 2.0 V$	V _{OUT}	x0.99		x1.01	V
		V _{OUT} < 2.0 V		-20		20	mV
	$-40^\circ C \leq T_A \leq 85^\circ C$	$V_{OUT} \ge 2.0 V$		x0.97		x1.03	V
		V _{OUT} < 2.0 V		-60		60	mV
Output Voltage Temp. Coefficient	-40°C ≤	T _A ≤ 85°C	$\Delta V_{OUT} / \Delta T_A$		±80		ppm/°C
Line Regulation	V _{OUT(NOM)} + 0.5	5 V \leq V _{IN} \leq 5.0 V	Line _{Reg}		0.02	0.10	%/V
Load Regulation	Iout = 1 m/	A to 300 mA	Load _{Reg}		15	40	mV
Dropout Voltage	I _{OUT} = 300 mA	V _{OUT} = 0.8 V	V _{DO}		0.56	0.72	V
		V _{OUT} = 0.9 V			0.51	0.65	
		$1.0 \text{ V} \le \text{V}_{\text{OUT}} < 1.2 \text{ V}$			0.46	0.59	
		$1.2 \text{ V} \le \text{V}_{\text{OUT}} < 1.4 \text{ V}$			0.39	0.50	
		$1.4 \text{ V} \le \text{V}_{\text{OUT}} < 1.7 \text{ V}$			0.35	0.44	
		$1.7 \text{ V} \leq \text{V}_{\text{OUT}} < 2.1 \text{ V}$			0.30	0.39	
		$2.1 \text{ V} \le \text{V}_{\text{OUT}} < 2.5 \text{ V}$			0.26	0.34	
		$2.5~\text{V} \leq \text{V}_{\text{OUT}} < 3.0~\text{V}$			0.25	0.30	
		$3.0 \text{ V} \leq \text{V}_{OUT} < 3.6 \text{ V}$			0.22	0.29	
Output Current			I _{OUT}	300			mA
Short Current Limit	V _{OUT} = 0 V		I _{SC}		60		mA
Quiescent Current			lq		50	75	μΑ
Standby Current	V _{CE} = 0 V	, T _A = 25°C	I _{STB}		0.1	1.0	μΑ
CE Pin Threshold Voltage	CE Input Voltage "H"		V _{CEH}	1.0			V
	CE Input Voltage "L"		V _{CEL}			0.4	
CE Pull Down Current			I _{CEPD}		0.3		μA
Power Supply Rejection Ratio			PSRR		65		dB
Output Noise Voltage	f = 10 Hz to 100 kHz, I_{OUT} = 30 mA, V _{OUT} = 1.2 V, V _{IN} = 3.2 V		V _N		65		μV_{rms}
Low Output Nch Tr. On Resistance	$V_{IN} = 4 V, V_{CE} = 0$	0 V, D version only	R _{LOW}		50		Ω

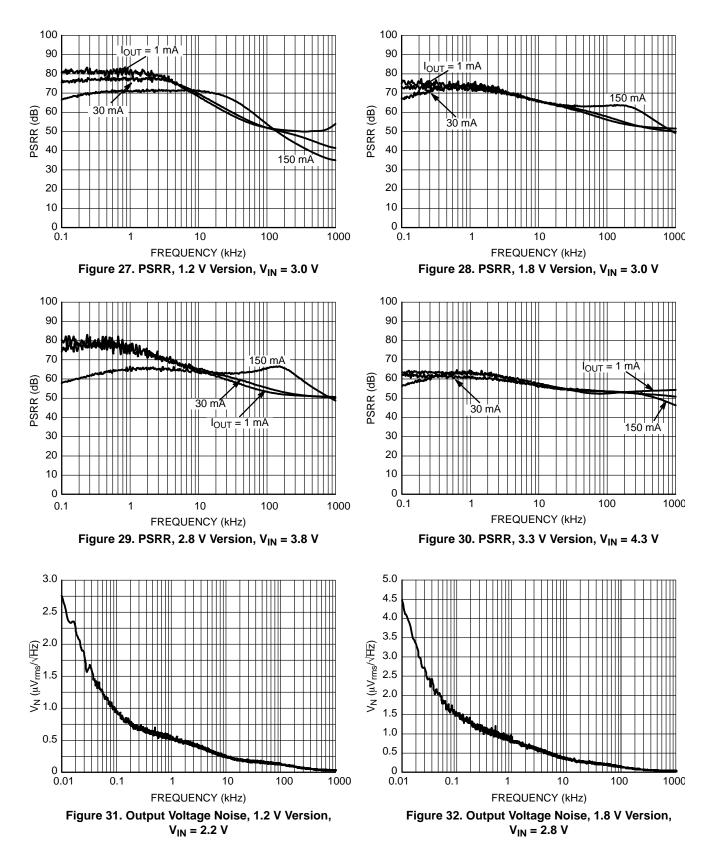
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

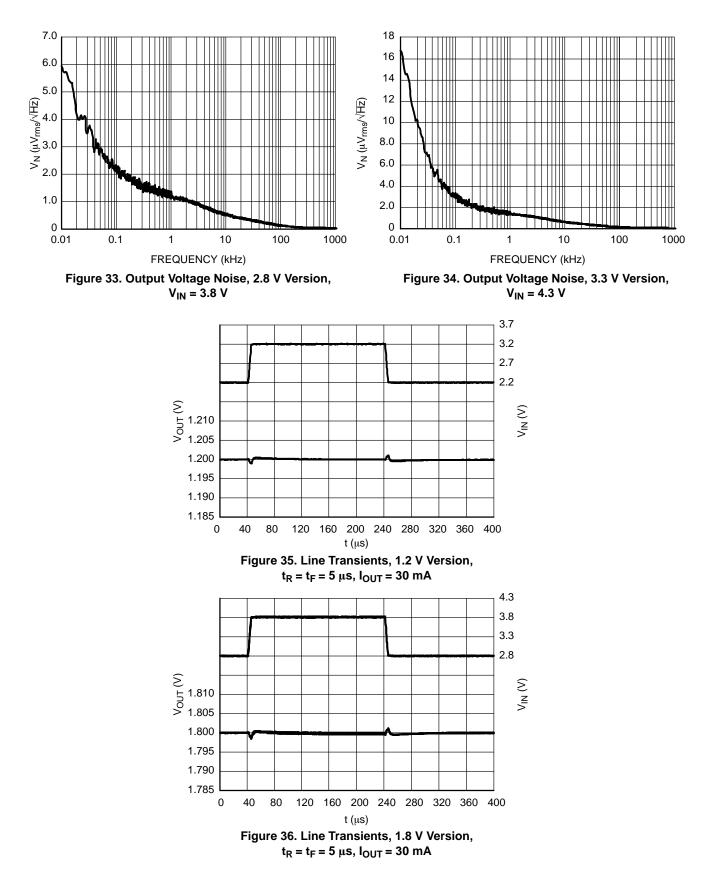


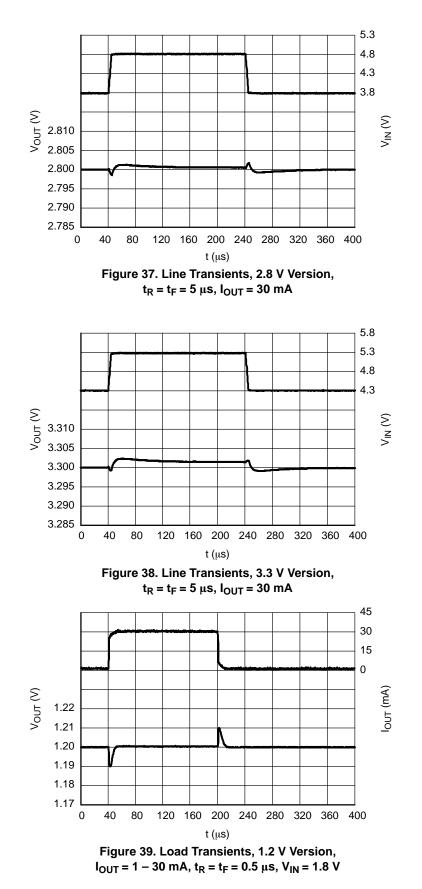


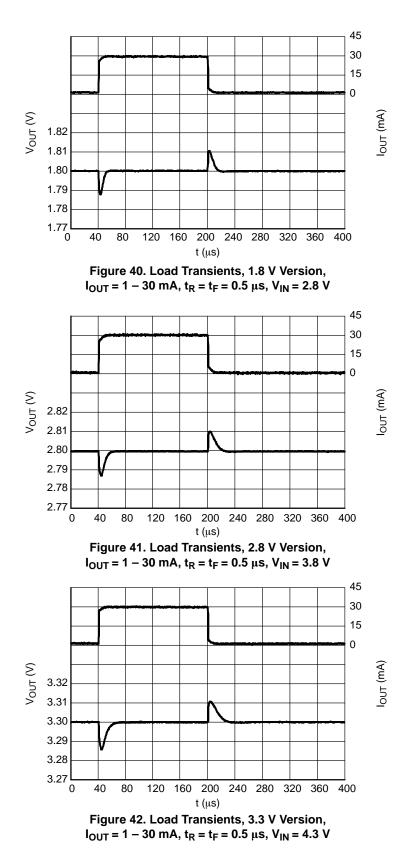




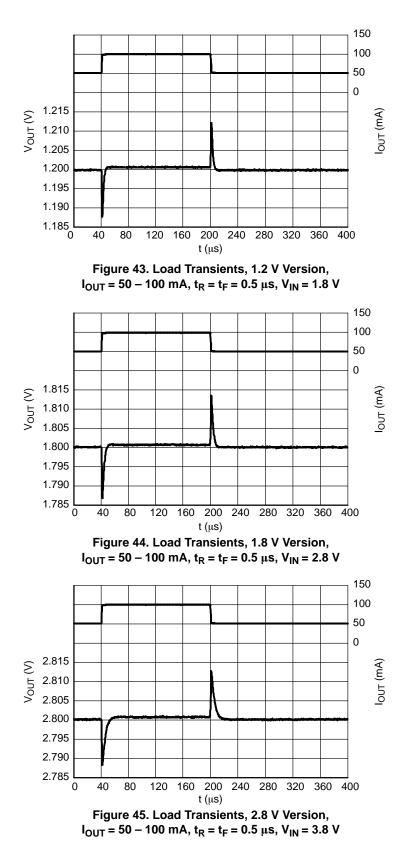


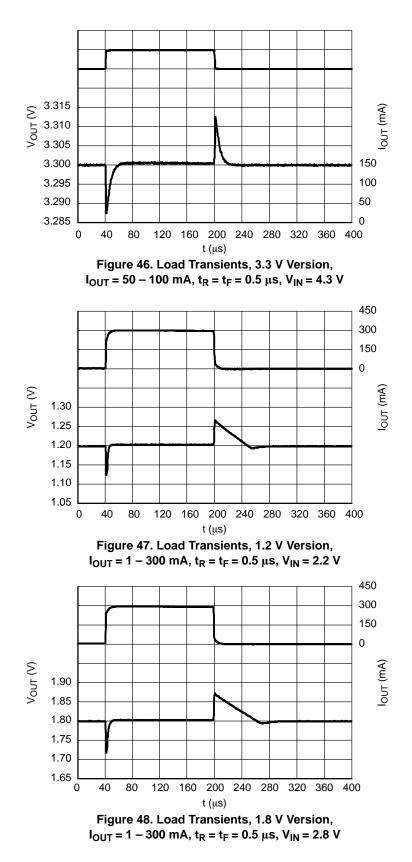


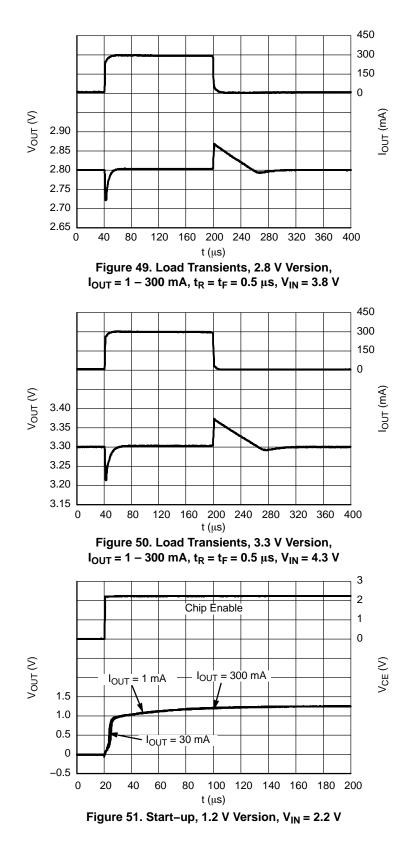




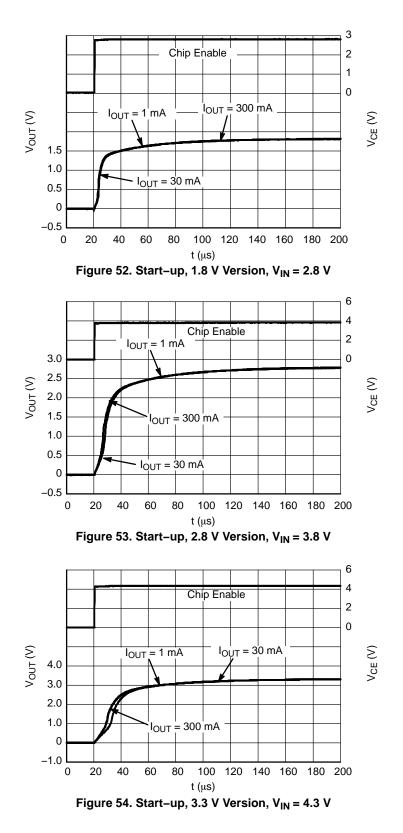




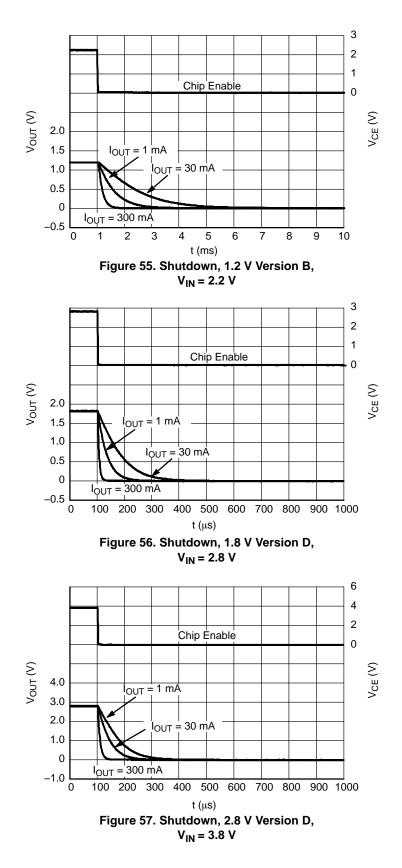




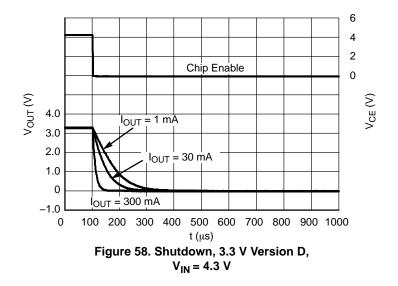
TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS



APPLICATION INFORMATION

A typical application circuit for NCP4683 series is shown in Figure 59.

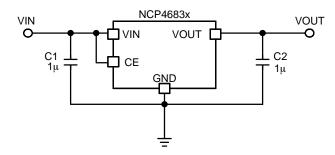


Figure 59. Typical Application Schematic

Input Decoupling Capacitor (C1)

A 1 μ F ceramic input decoupling capacitor should be connected as close as possible to the input and ground pin of the NCP4683. Higher values and lower ESR improves line transient response.

Output Decoupling Capacitor (C2)

A 1 μ F ceramic output decoupling capacitor is enough to achieve stable operation of the IC. If a tantalum capacitor is used, and its ESR is high, loop oscillation may result. The capacitors should be connected as close as possible to the output and ground pins. Larger values and lower ESR improves dynamic parameters.

Enable Operation

The enable pin CE may be used for turning the regulator on and off. The IC is switched on when a high level voltage is applied to the CE pin. The enable pin has an internal pull down current source. If the enable function is not needed connect CE pin to VIN.

Current Limit

This regulator includes fold–back type current limit circuit. This type of protection doesn't limit current up to current capability in normal operation, but when over current occurs, output voltage and current decrease until over current condition ends. Typical characteristics of this protection type can be observed in the Output Voltage vs. Output Current graphs shown in the typical characteristics chapter of this datasheet.

Output Discharger

The D version includes a transistor between VOUT and GND that is used for faster discharging of the output capacitor. This function is activated when the IC goes into disable mode.

Thermal

As power across the IC increase, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and also the ambient temperature affect the rate of temperature increase for the part. When the device has good thermal conductivity through the PCB the junction temperature will be relatively low in high power dissipation applications.

PCB layout

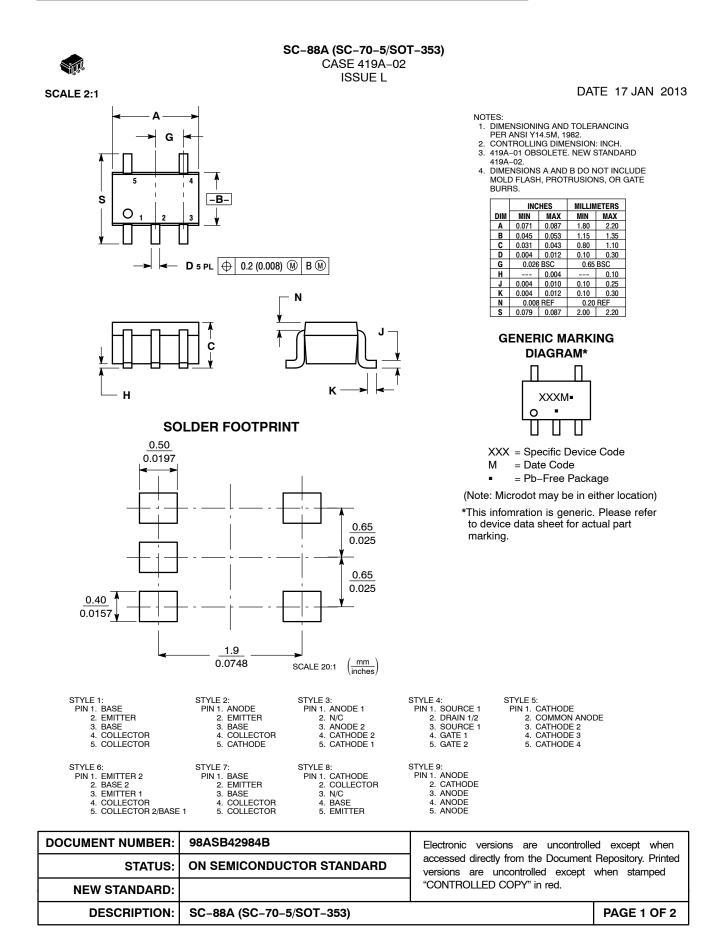
Make the VIN and GND line as large as practical. If their impedance is high, noise pickup or unstable operation may result. Connect capacitors C1 and C2 as close as possible to the IC, and make wiring as short as possible.

ORDERING INFORMATION

Device	Nominal Output Voltage	Description	Marking	Package	Shipping [†]	
NCP4683DMU09TCG	0.9	Auto discharge	Q1			
NCP4683DMU12TCG	1.20	Auto discharge	Q4			
NCP4683DMU18TCG	1.80	Auto discharge	R0			
NCP4683DMU185TCG	1.85	Auto discharge	Т0	UDFN4		
NCP4683DMU285TCG	2.85	Auto discharge	T1	(Pb-Free)	10000 / Tape & Reel	
NCP4683DMU31TCG	3.1	Auto discharge	S3			
NCP4683HMU12TCG	1.20	Standard	L4			
NCP4683HMU185TCG	1.85	Standard	P0			
NCP4683DSQ18T1G	1.80	Auto discharge	AH18			
NCP4683DSQ28T1G	2.80	Auto discharge	AH28	SC–70 (Pb–Free)	3000 / Tape & Reel	
NCP4683DSQ33T1G	3.30	Auto discharge	AH33	(

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*Marking codes for XDFN0808 packages are unified.
**To order other package and voltage variants, please contact your ON Semiconductor sales representative.









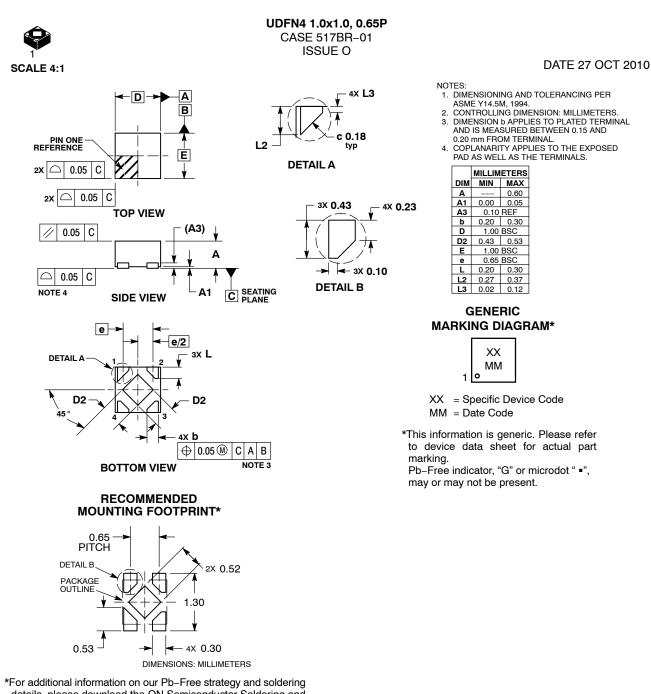
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ISSUE	REVISION	DATE
С	CONVERTED FROM PAPER DOCUMENT TO ELECTRONIC. REQ. BY N LAFEB- RE.	20 JUN 1998
D	CONVERTED FROM MOTOROLA TO ON SEMICONDUCTOR. ADDED STYLE 5. REQ. BY E. KIM.	24 JUL 2000
Е	ADDED STYLES 6 & 7. REQ. BY S. BACHMAN.	03 AUG 2000
F	DELETED DIMENSION V, WAS 0.3-0.44MM/0.012-0.016IN. REQ. BY G. KWONG.	14 JUN 2001
G	ADDED STYLE 8, REQ. BY S. CHANG; ADDED STYLE 9, REQ. BY S. BACHMAN; ADDED NOTE 4, REQ. BY S. RIGGS	25 JUN 2003
Н	CHANGED STYLE 6. REQ. BY C. LIM	28 APR 2005
J	CHANGED TITLE DESCRIPTION. REQ. BY B. LOFTS.	31 AUG 2005
К	CORRECTED TITLE AND DESCRIPTION TO SC-88A (SC-70-5/SOT-353). COR- RECTED MARKING DIAGRAM. REQ. BY D. TRUHITTE.	13 JUL 2010
L	ADDED SOLDER FOOTPRINT. REQ. BY I. MARIANO.	17 JAN 2013

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